

View Online at <https://aerobasegroup.com/nsn/5962-01-447-2495>

**Body Length:**

Between 0.800 inches and 0.840 inches

**Body Width:**

Between 0.392 inches and 0.408 inches

**Body Height:**

Between 0.080 inches and 0.100 inches

**Maximum Power Dissipation Rating:**

1.0 watts

**Operating Temperature Range:**

-55.0/+125.0 degrees celsius

**Storage Temperature Range:**

-65.0/+150.0 degrees celsius

**End Application:**

F16aircombf1t

**Features Provided:**

Monolithic and electrostatic sensitive and low power and burn in, mil-std-883, class b

**Inclosure Configuration:**

Leadless flat pack

**Output Logic Form:**

Complementary-metal oxide-semiconductor logic

**Terminal Surface Treatment:**

Solder

**Product Name:**

Microcircuit, memory, digital, cmos, 128k x 8 static random access memory (sram) low power, dual ce

**Voltage Rating And Type Per Characteristic:**

-0.5 volts input and 7.0 volts input

**Time Rating Per Characteristic:**

35.00 nanoseconds af output megawatts

**Memory Device Type:**

Ram

**Special Features:**

Selection criteria based on data retention current (icc4), per 3.2 of drawing

**Test Data Document:**

96906-mil-std-883 standard (includes industry or association standards, individual manufactureer standards, etc.).

**Terminal Type And Quantity:**

32 leadless

**Shelf Life:**

N/a

**Unit Of Measure:**

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**Demilitarization:**

No

**Fig:**

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